ARTICLE IN PRESS

Nuclear Instruments and Methods in Physics Research B xxx (2016) xxx-xxx

Contents lists available at ScienceDirect



Nuclear Instruments and Methods in Physics Research B



Investigation of electrically-active deep levels in single-crystalline diamond by particle-induced charge transient spectroscopy

W. Kada^{a,*}, Y. Kambayashi^{a,b}, Y. Ando^{a,b}, S. Onoda^b, H. Umezawa^c, Y. Mokuno^c, S. Shikata^d, T. Makino^b, M. Koka^b, O. Hanaizumi^a, T. Kamiya^b, T. Ohshima^b

^a Faculty of Science and Technology, Gunma University, Kiryu, Gunma 376-8515, Japan

^b Japan Atomic Energy Agency, Takasaki, Gunma 370-1292, Japan

^c National Institute of Advanced Industrial Science and Technology (AIST), 1-8-31 Midorigaoka, Ikeda, Osaka 563-8577, Japan

^d Kwansei Gakuin Univ., 2-1, Gakuen, Mita, Hyogo 669-1337, Japan

ARTICLE INFO

Article history: Received 15 September 2015 Received in revised form 15 December 2015 Accepted 28 December 2015 Available online xxxx

Keywords: CVD diamond Deep-levels Alpha particle induced charge transient spectroscopy (APQTS) Heavy ion induced charge transient spectroscopy (HIQTS)

1. Introduction

ABSTRACT

To investigate electrically-active deep levels in high-resistivity single-crystalline diamond, particleinduced charge transient spectroscopy (QTS) techniques were performed using 5.5 MeV alpha particles and 9 MeV carbon focused microprobes. For unintentionally-doped (UID) chemical vapor deposition (CVD) diamond, deep levels with activation energies of 0.35 eV and 0.43 eV were detected which correspond to the activation energy of boron acceptors in diamond. The results suggested that alpha particle and heavy ion induced QTS techniques are the promising candidate for in-situ investigation of deep levels in high-resistivity semiconductors.

© 2016 Elsevier B.V. All rights reserved.

BEAM INTERACTIONS WITH MATERIALS AND ATOMS

Single-crystalline diamond is regarded as an ideal material for a next-generation power devices since it has excellent electrical, mechanical and thermal properties. In addition, diamond attracts great attention for particle detectors owing to its high radiation tolerance [1–3]. For the development of electronic devices based on diamond, it is important to understand electrically active deep level defects in diamond because they affect device characteristics [4–6]. Thus, for the fabrication of electronic devices with designed characteristics, we have to clarify the origin of defects, such as vacancy-type, impurities and their complex, introduced during crystal growth and/or device fabrication process, and find out techniques to control them [7–9]. Although diamond crystal growth techniques have been advanced in recent years, it is still necessary to develop further crystal growth techniques for high quality crystalline diamond for electronic devices with extremely excellent characteristics.

Deep level transient spectroscopy (DLTS) is widely and commonly used to investigate deep levels in semiconductors [10-12].

* Corresponding author. Tel.: +81 277 30 1793. E-mail address: kada.wataru@gunma-u.ac.jp (W. Kada).

http://dx.doi.org/10.1016/j.nimb.2015.12.044 0168-583X/© 2016 Elsevier B.V. All rights reserved. However, the general DLTS cannot be well applied to characterizing defects in high-resistive wafers which are often used for radiation detectors. To improve the operability in such high-resistive targets, other approach for deep level evaluation was proposed using laser as an external excitation probe (photo induced current transient spectroscopy: PICTS) [13] and ions (scanning ion deep level transient spectroscopy: SIDLTS) [14–16]. Several defect levels in wide bandgap semiconductors e.g. hexagonal (4H) silicon carbide (SiC) substrate were measured from transient properties of charge induced by alpha particles, which is called as alpha particle induced charge transient spectroscopy (APQTS) [17]. Furthermore, similar charge transient spectroscopy using heavy ion microbeams as probe (heavy ion induced charge transient spectroscopy, HIQTS) has been developed in a beam line of the 3MV tandem accelerator at JAEA Takasaki [18]. For SIDLTS and QTS, dense charge (electron hole pairs) can be generated in samples by energetic charged particles even if metal electrode covers on the sample surface. Although most generated electrons/holes are immediately swept away from a sample to electrodes, some of them are trapped by deep level centers. Then, those trapped electrons/holes slowly escape to the conduction/valence band by thermal energy, depending on the activation energy of each trapping centers. These release (detrap) of charge from those traps can be observed in time scales

Please cite this article in press as: W. Kada et al., Investigation of electrically-active deep levels in single-crystalline diamond by particle-induced charge transient spectroscopy, Nucl. Instr. Meth. B (2016), http://dx.doi.org/10.1016/j.nimb.2015.12.044

of several microseconds, which is longer than that for the charge drift inside of the crystal obtained as a standard IBIC technique. Therefore, the activation energy of carrier trapping deep levels can be obtained by measuring cumulative charges slowly collected from a sample. Using QTS, the analysis of radiation detector based on SiC was successfully performed using focused heavy ion microprobe [17,18]. This suggests that QTS can be widely applicable to the observation of deep levels in other wide bandgap semiconductors such as diamond even with high resistivity. It is also expected that impurity atoms distributed in single crystalline diamond might act as electrically-active deep levels [19,20], if impurities have activation energies in ranges above several hundred meV (because such impurities are not activated to be 100% at room temperature). Especially, it is important to clarify impurities unintentionally doped in diamond during crystal growth in order to understand their effects on device characteristics as well as to improve crystal growth condition for high purity crystals. In this study, we investigate electrically-active deep levels in unintentionally doped single-crystalline diamond using APQTS and HIQTS techniques. Comparing with APQTS results obtained from intrinsic CVD diamond, we discuss unintentionally impurities doped in the diamond.

2. Materials and methods

2.1. Sample preparation

A free-standing single crystal unintentionally doped (UID) (001) diamond substrate with dimension of $3 \text{ mm} \times 3 \text{ mm}$ and thickness of 100 µm was fabricated by lift-off process using ion implantation [21]. A seed substrate with the size of $9 \times 9 \text{ mm}^2$ was implanted with 2 MeV carbon ions to the dose of 2×10^{16} ions/cm². After the ion implantation, single crystal diamond was grown on the substrate to the thickness of 100 µm by microwave plasma chemical vapor deposition (CVD) as described in Ref. [22]. The CVD grown layer was lifted-off by etching the graphitized ion implanted layer and the obtained plate was cut into 3×3 mm for the fabrication of an ionized particle detector with Ti/Pt/Au electrodes. In addition, a spectroscopic grade of single-crystalline intrinsic CVD diamond wafer with size of 4.6 mm \times 4.6 mm with a thickness of 50 μ m grown by Diamond Detectors, Ltd was also employed for comparison [23]. Quite low leakage current was observed to be less than 10^{-11} A through metalized uniform Ti/Pt/Au electrodes deposited on both sides of the diamond.

2.2. Experimental setup

Schematic illustration of charge transient spectroscopy (QTS) measurement system used in this study is shown in Fig. 1. APQTS was utilized with an ²⁴¹Am radiation checking source [17]. The source emits 5.5 MeV alpha particles with radiation activity of approximately 10⁶ Bq. The distance of the source to the diamond was adjusted to obtain the average count rate of approximately 10 cps during the measurement. A similar QTS system developed on a heavy ion microbeam line of the 3 MV tandem accelerator at JAEA Takasaki was also used [18]. An ion beam induced charge (IBIC) collection system is also installed in the heavy ion microbeam lines [24-26]. Carbon ions with 9 MeV which is one of the standard beams of the microbeam line was employed as the probe of HIQTS measurement in this study. To avoid damaging to the diamond wafers with heavy ions during HIQTS measurements, microbeam were scanned over detectors with a comparably large area of $400 \times 400 \,\mu\text{m}$. Also, average count rate of approximately 20 cps was used for the measurement to reduce the permanent damage induced in the crystal by heavy ions. The diamond detectors on a chip carrier were placed on a sample holder with cartridge heater and copper cold finger cooled by a liquid nitrogen (Lq. N_2) circulation system. The charges generated in diamond detector by ion incidence were collected using a charge sensitive preamplifier (CSP; ORTEC, 142A) and the output signals were recorded using a digital storage oscilloscope (DSO; Agilent, DSO2024A). Positive or negative bias voltage up to 50 V was applied to the detectors during QTS measurement.

Algorithm of the QTS measurement is illustrated in schematic step by step as shown in Fig. 2. Firstly, ion induced charge in time ranges up to a few hundred microseconds was recorded through the CSP by the DSO at various temperatures. Charge detrapped from deep level centers is observed after charge obtained within a sub-microsecond range. Therefore, comparing with standard ion beam induced charge (IBIC), it is necessary to measure charge transient for longer periods in the case of OTS. In this study, several output charge signals (pulse signals) obtained at each temperatures were averaged and decay of charge due to the CSP itself was de-convoluted from the averaged pulse signals as a background in order to obtain the actual transient signal structures as shown in Fig. 2(a). The decay constant of the CSP was determined by the signals obtained from non-damaged silicon and SiC samples. During measurements, temperature of the sample was monitored by thermocouples and the feedback was provided to the heater controller manipulated by the in-house software based on Lab-VIEW. APQTS were carried out at temperatures ranging from 160 to 360 K while HIQTS were done at temperatures ranging from 180 to 280 K in this study.

Then, rate window signal extraction method, which is similar to the method used in DLTS measurements [27,28], was employed to obtain the differences in the amount of cumulative charges at each time period. The cumulative charges obtained from each time period (from t_1 to t_2) was analyzed at each temperature to obtain the QTS spectrum as shown in Fig. 2(b). For the analyses, some combinations of time constant of t_1 and t_2 [For example, Index 0: (t_1 : 2 µs/ t_2 : 6 µs), Index 1: (t_1 : 6.8 µs/ t_2 : 20.2 µs), and Index 2: (t_1 : 15.2 µs/ t_2 : 45.6 µs) were used for the schematic] were selected to obtain the differences in cumulative charges at each temperature.

As a result, QTS spectra from each time period of t_1 and t_2 (Index 0,1,2...) were obtained from the structures of transient signals obtained at different temperatures. In this study, t_1/t_2 ratio was set equal to 3, however QTS analysis system is capable to process different ratio of the time span which should be optimized to obtain the peak in spectrum. If there are any peak appeared in spectrum, the position of the peak was then analyzed using different sets of the time period (t_1 and t_2) but the same ratio of t_1/t_2 . Finally, the peak shift of each QTS peaks would be analyzed in Arrhenius plot as shown in Fig. 2(c). And the activation energy of the peaks would be delivered from the slope of the Arrhenius plot.

3. Results and discussion

Fig. 3 shows (a) current–voltage (*I–V*) and (b) capacitance–voltage (*C–V*) characteristics of UID CVD diamond. From the asymmetric structure of reverse and forward current, the characteristics of Schottky diode formed on a p-type wafer can be confirmed. Also, it should be mentioned that negative self-bias of approximately –6 V was applied to the surface of the wafer as shown in *I–V* characteristics. The carrier concentration in the UID CVD diamond wafer was estimated to be approximately 10¹⁶/cm³ from the $1/C^2-V$ curve. The depletion layer of the UID CVD diamond at biases of 50 V which is a standard bias value used for QTS measurements was estimated to be approximately 50 µm. Ions used in this

Please cite this article in press as: W. Kada et al., Investigation of electrically-active deep levels in single-crystalline diamond by particle-induced charge transient spectroscopy, Nucl. Instr. Meth. B (2016), http://dx.doi.org/10.1016/j.nimb.2015.12.044

Download English Version:

https://daneshyari.com/en/article/8039953

Download Persian Version:

https://daneshyari.com/article/8039953

Daneshyari.com